



VDRM

T(AV)

Iтѕм dV/dt\*

dl/dt

**KEY PARAMETERS** 

8500V

1370A

17600A

1500V/µs

400A/µs

\* Higher dV/dt selections are available on request

DCR1370C85

#### Replaces DS6330-2

DS6330-3 August 2023 (LN42753)

**Phase Control Thyristor** 

### **FEATURES**

- Double Side Cooling
- High Surge Capability

### **APPLICATIONS**

- High Power Drives
- High Voltage Power Supplies
- Static Switches

### **VOLTAGE RATINGS**

Part and Ordering Number	Repetitive Peak Voltages Vdrm and Vrrm (V)	Conditions
		$Tvj = -40^{\circ}C$ to $125^{\circ}C$ ,
DCR1370C85*	8500	Idrm = Irrm = 300mA,
DCR1370C80	8000	Vdrm, Vrrm tp = 10ms
DCR1370C75	7500	VDSM & VRSM =
DCR1370C70	7000	Vdrm & Vrrm + 100V
		respectively

Lower voltage grades available.

\*8200V @ -40°C, 8500V @ 0°C

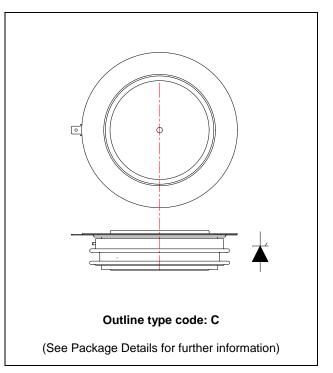
### **ORDERING INFORMATION**

When ordering, select the required part number shown in the Voltage Ratings selection table.

For example:

#### DCR1370C85

Note: Please use the complete part number when ordering and quote this number in any future correspondence relating to your order.





T<sub>case</sub> = 60°C unless stated otherwise

Symbol	Parameter	Test Conditions	Max.	Units
Double Si	de Cooled			
Ιτ(Αν)	Mean on-state current	Half wave resistive load	1370	А
It(rms)	RMS value	-	2150	А
Іт	Continuous (direct) on-state current	-	2160	А

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## SURGE RATINGS

Symbol	Parameter	Test Conditions	Max.	Units
Ітѕм	Surge (non-repetitive) on-state current	10ms half sine, Tcase = 125°C	17.6	kA
l²t	I <sup>2</sup> t for fusing	VR = 0	1.55	MA <sup>2</sup> s

# THERMAL AND MECHANICAL RATINGS

Symbol	Parameter	Parameter Test Conditions		Min.	Max.	Units
	Thermal resistance - junction to case	Double side cooled	DC	-	10.1	°C/kW
Rth(j-c)			Anode DC	-	17.6	°C/kW
		Single side cooled	Cathode DC	-	23.9	°C/kW
Rth(c-h) T	Thermal resistance - case to heatsink	Clamping force 37kN (with mounting compound)	Double side	-	2.5	°C/kW
			Single side	-	5.0	°C/kW
Tvj	Virtual junction temperature Blocking VDRM / VRRM		-	125	°C	
Tstg	Storage temperature range	ure range		-55	125	°C
Fm	Clamping force			33	41	kN

# **DYNAMIC CHARACTERISTICS**

Symbol	Parameter	Test Condition	IS	Min.	Max.	Units
Irrm/Idrm	Peak reverse and off-state current	At VRRM/VDRM, Tcase = 125°C	,	-	300	mA
Vтм	Instantaneous forward voltage	At 4000A peak, Tj = 125°C		3.90	4.40	V
dV/dt	Max. linear rate of rise of off-state voltage	То 67% Vdrm, Тј = 125°С, ga	ate open	-	1500	V/µs
dl/dt	Rate of rise of on-state current	From 67% VDRM to 2x $I_{T(AV)}$ Gate source 30V, 10 $\Omega$	Repetitive 50Hz	-	200	A/µs
uivat		tr < 0.5µs, Tj = 125°C	Non-repetitive	-	400	A/µs
Veren	Threshold voltage - Low level	500A to 2000A at Tcase = 1	25°C	-	1.18	V
<b>V</b> τ(το)	Threshold voltage - High level	2000A to 7000A at T <sub>case</sub> = 125°C		-	1.32	V
	On-state slope resistance - Low level	500A to 2000A at T <sub>case</sub> = 125°C		-	0.84	mΩ
ľτ	On-state slope resistance - High level	tance - High level 2000A to 7000A at Tcase = 125°C		-	0.77	mΩ
tgd	Delay time	$V_D = 67\% V_{DRM}$ , gate source 30V, 10 $\Omega$ tr = 0.5µs, Tj = 25°C		-	3	μs
tq	Turn-off time	Tj = 125°C, V <sub>R</sub> = 200V, dl/dt = 1A/µs, dV <sub>DR</sub> /dt = 20V/µs linear		-	1200	μs
Qs	Stored charge	Iτ = 2000A, Tj = 125°C, dl/dt = 1A/μs		4290	5940	μC
Irr	Reverse recovery current	Vr(peak) ~ 3900V, Vrm ~ 2600V		47	54	А
Ŀ	Latching current	Tj = 25°C, V <sub>D</sub> = 5V		-	3	А
Ін	Holding current	Тј = 25°С, Rg-к = ∞, Iтм = 50	0A, I⊤ = 5A	-	300	mA

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## GATE TRIGGER CHARACTERISTICS AND RATINGS

Symbol	Parameter	Test Conditions	Max.	Units
Vgt	Gate trigger voltage	Vdrm = 5V, Tcase = 25°C	1.5	V
Vgd	Gate non-trigger voltage	At 50% Vdrm, Tcase = 125°C	0.4	V
Іст	Gate trigger current	Vdrm = 5V, Tcase = 25°C	350	mA
Igd	Gate non-trigger current	At 50% Vdrm, Tcase = 125°C	15	mA

## CURVES

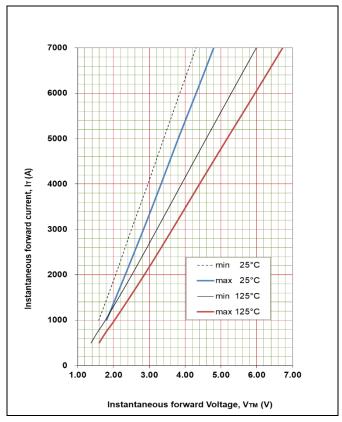


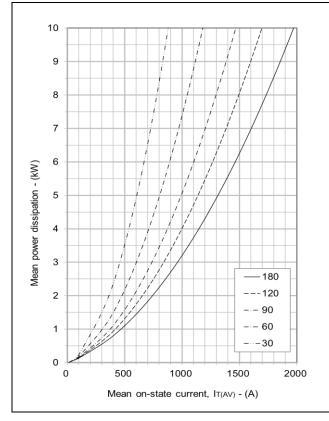
Fig. 2 Maximum & minimum on-state characteristics

## **VTM EQUATION**

$$V_{TM} = A + B.ln(I_T) + C.I_T + D.\sqrt{I_T}$$

Where A = 0.937135 B = 0.030939 C = 0.000730 D = 0.004730 These values are valid for  $T_j$  = 125°C for I<sub>T</sub> 500A to 7000A

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Fig. 3 On-state power dissipation - sine wave

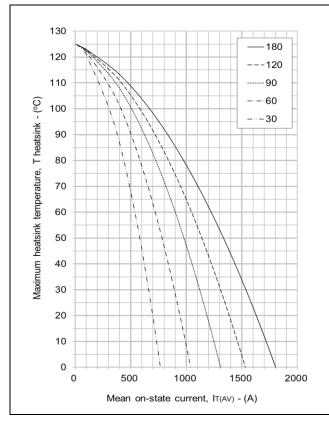


Fig. 5 Maximum permissible heatsink temperature, double side cooled - sine wave

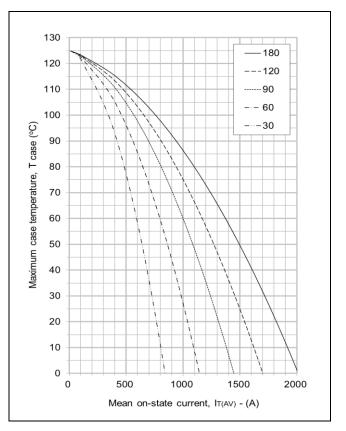


Fig. 4 Maximum permissible case temperature, double side cooled - sine wave

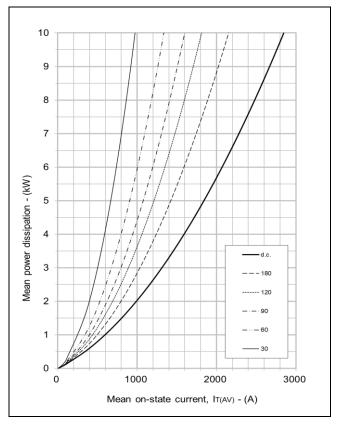


Fig. 6 On-state power dissipation - rectangular wave

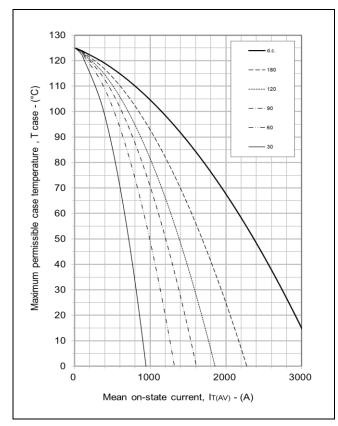
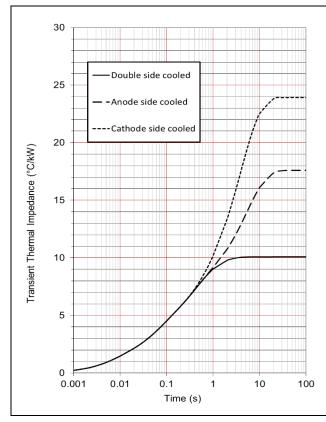


Fig. 7 Maximum permissible case temperature, double side cooled - rectangular wave



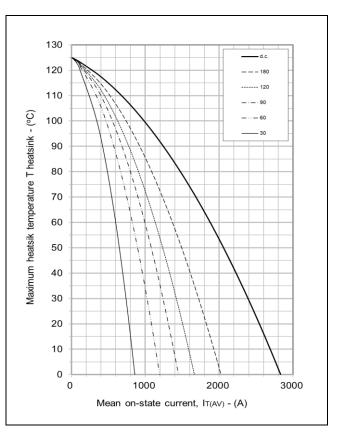


Fig. 8 Maximum permissible heatsink temperature, double side cooled - rectangular wave

		1	2	3	4
Double side	Ri(°C/kW)	1.104	2.576	4.510	1.901
cooled	Ti(s)	0.006	0.052	0.382	1.060
Anode side cooled	Ri(°C/kW)	1.098	2.457	4.047	9.999
	Ti(s)	0.006	0.050	0.313	5.270
Cathode side	Ri(°C/kW)	1.152	2.893	2.406	17.479
cooled	Ti(s)	0.006	0.058	0.378	3.970

$$Z_{th} = \sum_{i=1}^{i=4} R_i \cdot \left(1 - \exp\left(-\frac{T}{T_i}\right)\right)$$

∆R<sub>th(j-c)</sub> Conduction

Tables show the increments of thermal resistance R  $_{\text{fr}(j-q)}$  when the device operates at conduction angles other than d.c.

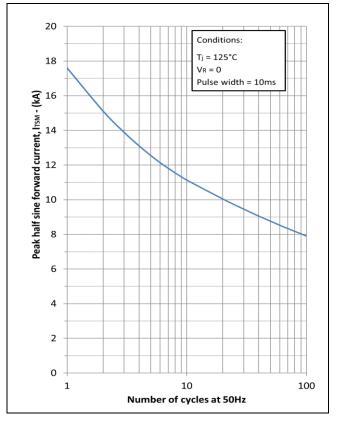
	Double side cooling			Anode Side Cooling			ΙĒ	С
	$\Delta Z_{\text{th}}(z)$				$\Delta Z_{th}(z)$		Ì	
θ°	sine.	rect.		θ°	sine.	rect.		θ°
180	1.95	1.26	[	180	1.95	1.26		180
120	2.32	1.89		120	2.32	1.89	l [	120
90	2.74	2.27		90	2.74	2.27		90
60	3.14	2.70	[	60	3.14	2.70		60
30	3.46	3.19		30	3.46	3.19	1	30
15	3.61	3.47		15	3.62	3.47		15

Cathode Sided Cooling					
	$\Delta Z_t$	<sub>h</sub> (z)			
θ°	sine.	rect.			
180	1.95	1.26			
120	2.31	1.88			
90	2.72	2.26			
60	3.12	2.68			
30	3.43	3.17			
15	3.58	3.44			

Fig. 9 Maximum (limit) transient thermal impedance - junction to case (degC/kW)

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Fig. 10 Multi-cycle surge current

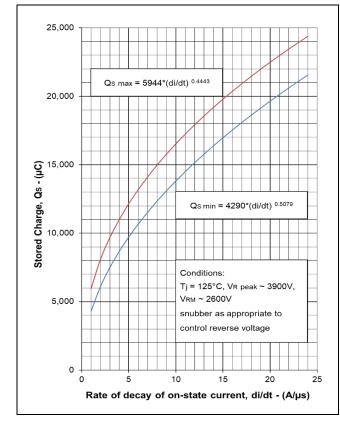
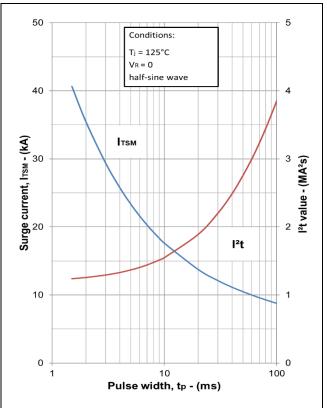
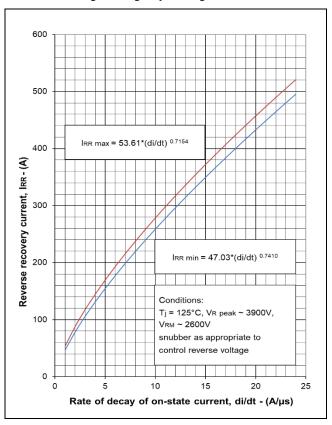


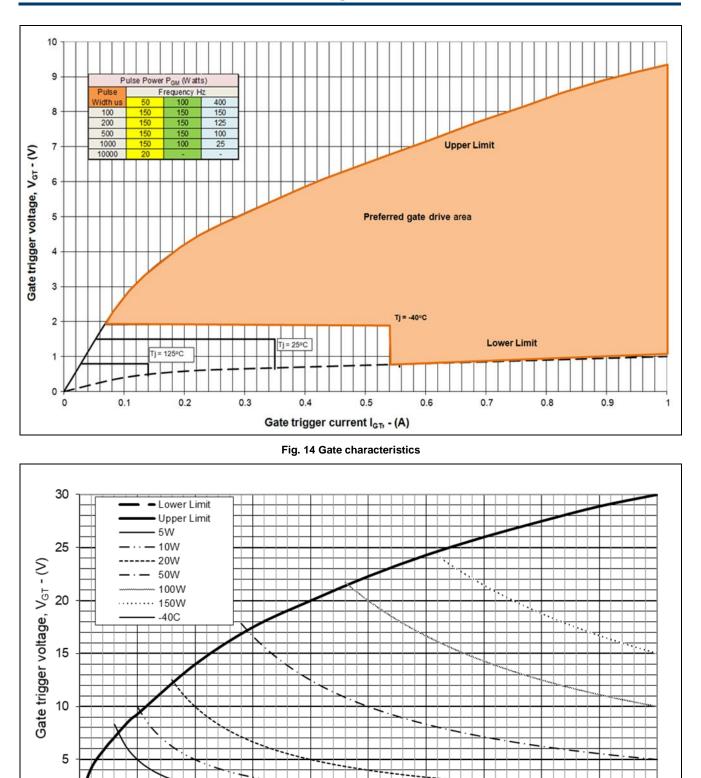
Fig. 12 Reverse recovery charge





#### Fig. 11 Single-cycle surge current

Fig. 13 Reverse recovery current



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5

Gate trigger current, IGT - (A)

6

7

8

9

4

2

3

0

0

1

10

Fig. 15 Gate characteristics

### PACKAGE DETAILS

For further package information, please contact Customer services.

All dimensions in mm, unless stated otherwise.

DO NOT SCALE

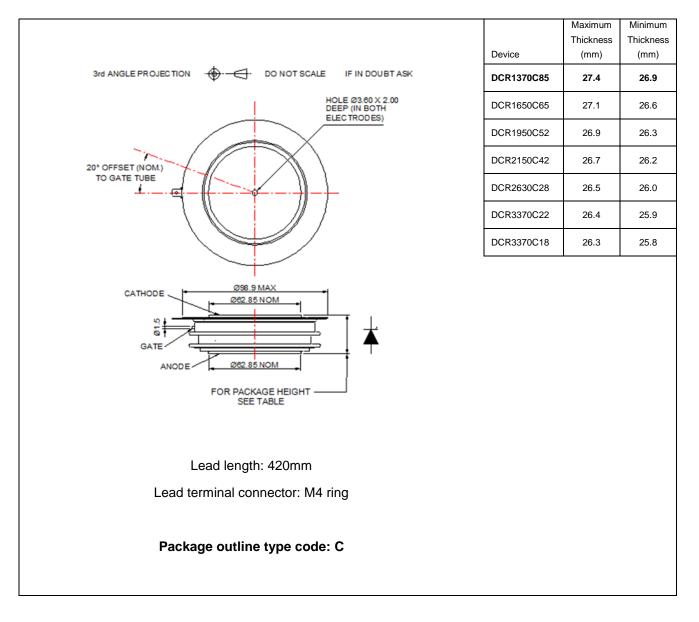


Fig. 16 Package outline

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